

THIN WALL PACKAGING 2009

CONFERENCE PROCEEDINGS NOW AVAILABLE

AMI Conferences is pleased to announce that the proceedings from Thin Wall Packaging 2009 have now been published.

This unique business event was dedicated to the Thin Wall Packaging industry and the programme covered many of the latest material and technology developments as well as providing a stimulating business forum.

The conference provided a global picture of the Thin Wall Packaging industry and offered an opportunity to gain knowledge of new developments and future trends influencing the industry.

If your company has an interest in the industry then do not miss this opportunity to acquire the presentations provided by so many of the industry's leading players.

To purchase copies of the newly released Thin Wall Packaging 2009 proceedings, simply print out this leaflet, fill out the enclosed order form and fax it back to us + 44 (0) 117 311 1534.

19-21 October 2009
Maritim Hotel, Cologne, Germany

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THIN WALL PACKAGING 2009

C O N F E R E N C E

P R O G R A M M E

SESSION 1 – PACKAGING TRENDS

Packaging at a crossroads

Mr. Charles Reuland, Founder,
THE PACKAGING COMMUNITY.ORG, Belgium

High barrier CPET tray (AMPET) applications for packaging of shelf-stable (ambient) food products

Mr. Frank Oestervemb, Innovations Manager,
R. FAERCH PLAST A/S, Denmark

Plastic packaging in a changing world - smaller, thinner, more economical and sustainable

Mr. Stefan Foitlinski, Regional Sales Director,
SUPERFOS DEUTSCHLAND GmbH, Germany

SESSION 2 - ADVANCES IN TECHNOLOGY

Polypropylene cup light-weighting by conversion from injection moulding to thermoforming

Mr. Piaras de Cléir, Principal Engineer,
KRAFT FOODS, United States

Barrier by injection moulding – new developments challenge the market dominance held by multilayer thermoforming

Mr. Morten Augestad, Advisor,
NORNER INNOVATION AS, Norway

Thermoforming – the opportunity for sustainable packaging

Mr. Claus Weinert, Sales Manager and Product Manager,
ILLIG MASCHINENBAU GmbH & Co.KG, Germany

Investing in sustainability – case study on downweighting

Mr. Andrew Osborne-Smith, Managing Director,
ANSON PACKAGING, United Kingdom

Going thin in packaging

Dr. Kurt Brunner, Application Technology Leader
Rigid Packaging & Consumer Durables,
DOW EUROPE GmbH, Switzerland

Ecological packaging systems with modern technology. Thin wall packaging – IML

Mr. Rüdiger Grings, Product Manager Packaging Products,
NETSTAL-MASCHINEN AG, Switzerland

The easy start-up of a new product on a thermoforming machine

Mr. Thomas Huber, Product Manager,
KIEFEL, Germany

MARKET OVERVIEW

Thin wall packaging market overview

Mr. Jon Nash, Research Director,
AMI CONSULTING, United Kingdom

SESSION 3 - DEVELOPMENTS IN MATERIALS & PACKAGING

Barrier PP tray containing O2 scavenger for retort applications

Mr. Benjamin Bourbon, Technical Assistance Manager,
RPC CONTAINERS, France

Delivering PP solutions to the TWP market

Mr. Diederik Goyvaerts, Technical Marketing,
SABIC EUROPE, The Netherlands

Polystyrene – the light beauty

Mr. Herbert Fietzek, Director,
BASF SE, Germany

Trends and developments in PP thin wall packaging through additive solutions

Mr. Sami T.K. Palanisami, Market Manager Europe & Middle East,
MILLIKEN EUROPE BVBA, Belgium

SESSION 4 - RECYCLING & BIODEGRADABLE POLYMERS

The polystyrene end-of-life management in Europe

Mr. Philippe Montagne, Product Manager Polystyrene Europe,
TOTAL PETROCHEMICALS, Belgium

Biodegradable and compostable polymers, coextruded structures, extrusion coating and lamination

Mr. Stefano Facco, Dir. New Business Development,
NOVAMONT S.p.A., Italy

Closing material loops: post consumer plastics recycling in Germany

Dr. Gillian Gerke, Group Manager,
DKR mbH, Germany

MULTILAYER PACKAGING FILMS 2009

International business and technology conference for the barrier films industry, **16-18 November 2009**, Maritim Hotel, Cologne, Germany

FIRE RESISTANCE IN PLASTICS 2009

Trends and technical developments in the international flame retardant industry, **30 November -2 December 2009**, Sheraton Offenbach Hotel, Offenbach/Frankfurt, Germany

PIPELINE COATING 2010

Technology and market developments in the global pipeline protection industry, **1-3 February 2010**, The Imperial Riding School Vienna, a Renaissance Hotel, Vienna, Austria

THE GRASS YARN & TUFTERS FORUM 2010

9-11 February 2010, Austria Trend Savoyen Hotel, Vienna, Austria

THERMOPLASTIC CONCENTRATES 2010

An international marketing, business and technical conference for the thermoplastic concentrate industry
16-18 February 2010, The Crowne Plaza San Marcos Golf Resort, Phoenix, Arizona, United States

CABLES 2010

The international conference and exhibition for the plastics cable industry **9-11 March 2010**, Maritim Hotel, Cologne, Germany

PVC FORMULATION 2010

Market trends and technical developments in PVC additives and compounding **16-18 March 2010**, Maritim Hotel, Cologne, Germany

POLYETHYLENE FILMS 2010

The business conference and exhibition for the Polyethylene Film industry **18-19 March 2010**, The Shores Resort & Spa, Daytona Beach, Florida, United States

MASTERBATCH ASIA 2010

The International business conference on the use of Masterbatch in plastics **22-24 March 2010**, Hilton Hotel, Singapore

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